



November 28, 2005 09:00 AM US Eastern Timezone

Freescale Manufactures World's First 24-Mbit Silicon Nanocrystal Memory

http://home.businesswire.com/portal/site/google/index.jsp?ndmViewId=news_view&newsId=20051128005430&newsLang=en

AUSTIN, Texas--(BUSINESS WIRE)--Nov. 28, 2005--Achievement represents a crucial step in the delivery of next-generation non-volatile embedded memories

A non-volatile memory technology which is denser, faster and more cost-effective than conventional flash memory technology is closer to production, due to the continued efforts of Freescale Semiconductor (NYSE:FSL) (NYSE:FSL.B) to optimize the properties of silicon nanocrystals. Freescale has manufactured the world's first 24-megabit (Mbit) memory array based on silicon nanocrystals, a major step toward replacing conventional floating gate-based flash memories.

The 24-Mbit memory array technology was manufactured at Freescale's Austin Technology & Manufacturing Center using 90-nanometer (nm) CMOS bulk technology. The production of a working 24-Mbit memory device requires that silicon nanocrystals be deposited with excellent uniformity and integration approaches that keep the nanocrystal properties intact during subsequent processing. In successfully achieving this, Freescale has overcome major challenges to introducing this technology into production.

"The industry anticipates that conventional embedded flash memory technology will reach its scaling limit within the next four years due to high-operating voltage, fabrication process complexity and cost," said Freescale Chief Technology Officer Dr. Claudine Simson. "A viable alternative is crucial for key suppliers to automotive, wireless and consumer markets to continue to scale their products and add new functionality. Silicon nanocrystal technology offers lower operating voltages, reduced memory module size, simpler process flow and lower manufacturing costs. Additionally, it requires no new materials or wafer fabrication equipment, allowing for immediate compatibility with existing production wafer fabs. By demonstrating that silicon-nanocrystal memories can be reliably produced at higher densities, we have taken yet another step in establishing technology leadership in the embedded non-volatile memory market."

As the industry begins manufacturing at smaller geometries -- 90-nm and smaller -- embedding floating gate-based flash becomes difficult to produce cost-effectively. At those dimensions, the chip area consumed by the 9-12V high-voltage transistors required to write and erase the conventional flash module cannot be scaled down. Furthermore, engineers cannot reduce the high voltage in floating gate-based flash without compromising reliability or risking memory failures and loss of data.

Silicon nanocrystal memories are part of an advanced class of memory technologies called thin-film storage. They are more scaleable than conventional floating gate-based flash technology, as their tunnel oxide thickness can be reduced without impacting data retention. The charge is stored on isolated nanocrystals and is lost only from those few nanocrystals that align with defects in the tunnel oxide - while the same defects would result in significant charge loss from a conventional floating gate. A thinner tunnel oxide permits lower-voltage operation, substantially reducing the memory module area needed to generate the bit-cell programming voltages, and allowing for significant wafer processing simplifications and manufacturing cost reductions. The combination of higher bit density and reduced cost translates to lower cost per bit to embed silicon nanocrystal memories. Freescale expects significant reductions in cost per bit of silicon nanocrystal thin-film storage memories.

"Silicon nanocrystal storage is a promising alternative to industry-standard embedded NOR memory, as it offers the capability of lowering both the size and cost of the device," said Semico Analyst Jim Handy. "Freescale's achievement is a key development in the introduction of the 'faster, cheaper' memory that the semiconductor industry increasingly requires."

Freescale successfully pioneered the use of nanocrystals in memory devices in March 2003, and discussed the demonstration of its first-of-its-kind 4-Mbit nanocrystal memory device at the December 2003 IEEE International Electron Devices Meeting (IEDM) in a paper entitled "A 6-V embedded 90-nm silicon nanocrystal nonvolatile memory."

About Freescale Semiconductor

Freescale Semiconductor, Inc. (NYSE:FSL) (NYSE:FSL.B) is a global leader in the design and manufacture of embedded semiconductors for the automotive, consumer, industrial, networking and wireless markets. Freescale became a publicly traded company in July 2004 after more than 50 years as part of Motorola, Inc. The company is based in Austin, Texas, and has design, research and development, manufacturing or sales operations in more than 30 countries. Freescale, a member of the S&P 500(R), is one of the world's largest semiconductor companies with 2004 sales of \$5.7 billion (USD). www.freescale.com.

Freescale and the Freescale logo are trademarks of Freescale Semiconductor Inc. All other product or service names are the property of their respective owners. (C) Freescale Semiconductor Inc. 2005

Contacts

Freescale Semiconductor

North America:

Glaston Ford, 512-895-6466

glaston@freescale.com

or

Lois Paul & Partners for Freescale

Emilie Harris, 512-638-5321

Emilie_harris@lpp.com

or

Asia Pacific:

Gloria Shiu, (85-22) 666-8237

gloria.shiu@freescale.com

or

Europe, Middle East and Africa:

Regina Cirmonova, (41-22) 799-1258

regina.cirmonova@freescale.com

or

Japan:

Koichi Yoshimura, (81-3) 5437-9350

koichi.yoshimura@freescale.com

or

Latin America:

Ruth Ruiz, 480-814-4897

ruth.ruiz@freescale.com

Terms of Use | © Business Wire 2005
